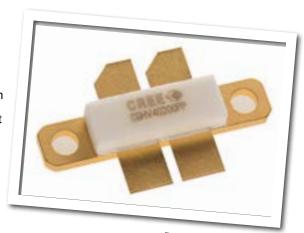


CGHV40200PP

200 W, 50 V, GaN HEMT

Cree's CGHV40200PP is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT). The CGHV40200PP, operating from a 50 volt rail, offers a general purpose, broadband solution to a variety of RF and microwave applications. GaN HEMTs offer high efficiency, high gain and wide bandwidth capabilities making the CGHV40200PP ideal for linear and compressed amplifier circuits. The transistor is available in a 4-lead flange package.



Package Type: 440199 PN: CGHV40200PP

Typical Performance Over 1.7-1.9 GHz (T_c = 25°C), CW

Parameter	1.7 GHz	1.8 GHz	1.9 GHz	Units
Small Signal Gain	21.7	21.0	20.1	dB
Gain @ P _{in} = 38 dBm	16.5	16.1	15.4	dB
P _{OUT} @ P _{IN} = 38 dBm	270	250	218	W
Drain Efficiency @ P _{IN} = 38 dBm	64	67	65	%

FEATURES

- Up to 3.0 GHz Operation
- 21 dB Small Signal Gain at 1.8 GHz
- 250 W typical P_{SAT}
- 67 % Efficiency at P_{SAT}
- 50 V Operation

APPLICATIONS

- 2-Way Private Radio
- Broadband Amplifiers
- Cellular Infrastructure
- Test Instrumentation
- Class A, AB, Linear amplifiers suitable for OFDM, W-CDMA, EDGE, CDMA waveforms

Large Signal Models Available for ADS and MWO





Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	$V_{\scriptscriptstyle DSS}$	125	Volts	25°C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25°C
Storage Temperature	T _{STG}	-65, +150	°C	
Operating Junction Temperature	$T_{_{\!J}}$	225	°C	
Maximum Forward Gate Current ¹	I _{GMAX}	20.8	mA	25°C
Maximum Drain Current ¹	I _{DMAX}	8.7	A	25°C
Soldering Temperature ²	T _s	245	°C	
Screw Torque	τ	80	in-oz	
Thermal Resistance, Junction to Case ³	$R_{\scriptscriptstyle{\theta JC}}$	0.94	°C/W	85°C
Case Operating Temperature ^{3,4}	T _c	-40, +150	°C	

Note:

Electrical Characteristics (T_c = 25°C)

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics ¹						
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V _{DC}	$V_{DS} = 10 \text{ V, } I_{D} = 20.8 \text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V _{DC}	$V_{DS} = 50 \text{ V, } I_{D} = 2.0 \text{ A}$
Saturated Drain Current ²	I _{DS}	15.6	18.7	-	А	$V_{DS} = 6.0 \text{ V, } V_{GS} = 2.0 \text{ V}$
Drain-Source Breakdown Voltage	$V_{\rm BR}$	150	-	-	V _{DC}	$V_{gs} = -8 \text{ V, } I_{D} = 20.8 \text{ mA}$
RF Characteristics ^{3,4} (T _c = 25°C, F ₀ = 1.8 GH	Iz unless otherv	vise noted)				
Small Signal Gain	G _{ss}	17.75	20.0	-	dB	$V_{DD} = 50 \text{ V, } I_{DQ} = 1.2 \text{ A, } P_{IN} = 10 \text{ dBm}$
Power Gain	P _G	15.05	16.0	-	dB	$V_{DD} = 50 \text{ V, } I_{DQ} = 1.2 \text{ A, } P_{IN} = 38 \text{ dBm}$
Power Output	P _{out}	200	250	-	W	$V_{DD} = 50 \text{ V, } I_{DQ} = 1.2 \text{ A, } P_{IN} = 38 \text{ dBm}$
Drain Efficiency⁵	η	60	69	-	%	$V_{DD} = 50 \text{ V, } I_{DQ} = 1.2 \text{ A, } P_{IN} = 38 \text{ dBm}$
Output Mismatch Stress	VSWR	-	-	3:1	Ψ	No damage at all phase angles, $V_{DD} = 28 \text{ V}, I_{DQ} = 1.2 \text{ A},$ $P_{OUT} = 200 \text{ W CW}$
Dynamic Characteristics ⁶						
Input Capacitance	C _{GS}	-	29.3	-	pF	$V_{DS} = 28 \text{ V}, V_{gs} = -8 \text{ V}, f = 1 \text{ MHz}$
Output Capacitance	C _{DS}	-	7.3	-	pF	$V_{DS} = 28 \text{ V, } V_{gs} = -8 \text{ V, f} = 1 \text{ MHz}$
Feedback Capacitance	C_{GD}	-	0.61	-	pF	$V_{DS} = 28 \text{ V}, V_{gs} = -8 \text{ V}, f = 1 \text{ MHz}$

Notes

¹ Current limit for long term, reliable operation per side of the device

² Refer to the Application Note on soldering at <u>www.cree.com/RF/Document-Library</u>

 $^{^{\}rm 3}$ CGHV40200PP at P $_{\rm DISS}$ = 166 W.

⁴ See also, the Power Dissipation De-rating Curve on Page .

¹ Measured on wafer prior to packaging per side of device.

² Scaled from PCM data.

 $^{^{\}scriptscriptstyle 3}$ Measured in CGHV40200PP-TB

 $^{^4\,\}mbox{I}_{\mbox{\tiny DQ}}$ of 1.2 A is by biasing each device at 0.6 A.

⁵ Drain Efficiency = P_{out} / P_{DC}

⁶ Capacitance values are for each side of the device.



Typical Performance

Figure 1. - Gain and Return Losses vs Frequency measured in CGHV40200PP-TB V_{DD} = 50 V, I_{DQ} = 1.2 A, Freq = 1.5 - 2.0 GHz

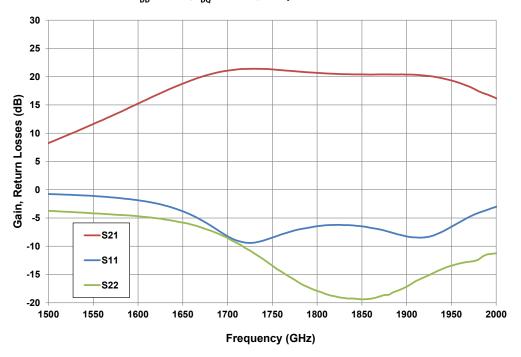
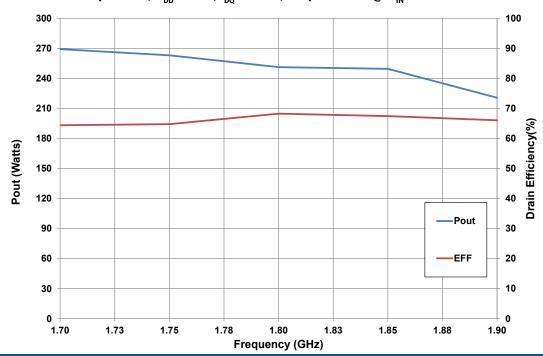


Figure 2. - Output Power and Drain Efficiency vs Frequency measured in CGHV40200PP-TB CW Operation, V_{DD} = 50 V, I_{DO} = 1.2 A, Output Power @ P_{IN} = 38 dBm





Typical Performance

Figure 3. - Gain and Drain Efficiency vs Output Power measured in CGHV40200PP-TB
CW Operation, $V_{\rm DD}$ = 50 V, $I_{\rm DO}$ = 1.2 A

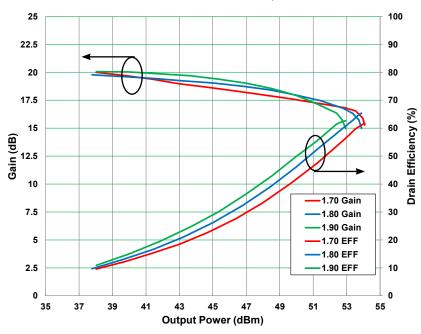
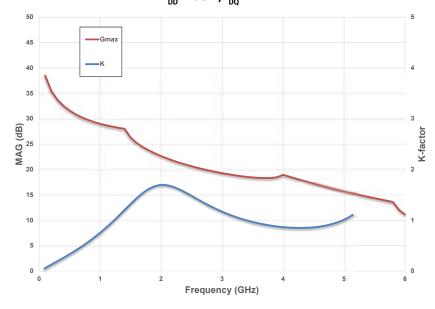


Figure 4. - Simulated Maximum Avaliable Gain and K-factor of the CGHV40200PP $V_{\rm DD}$ = 50 V, $I_{\rm DQ}$ = 1.2 A

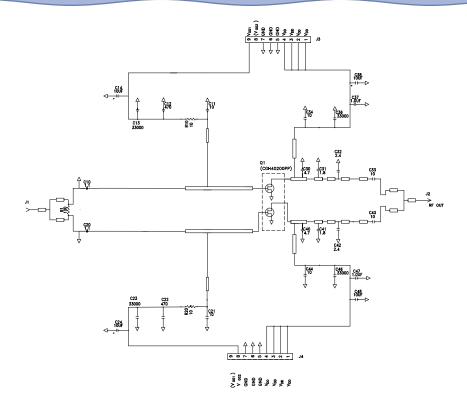


Electrostatic Discharge (ESD) Classifications

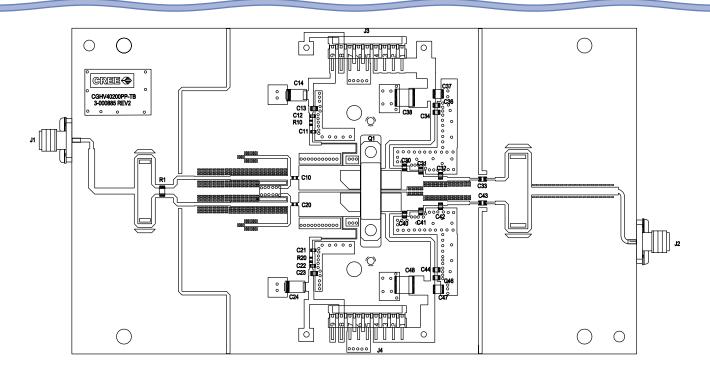
Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1A > 250 V	JEDEC JESD22 A114-D
Charge Device Model	CDM	1 < 200 V	JEDEC JESD22 C101-C



CGHV40200PP-TB Demonstration Amplifier Circuit Schematic



CGHV40200PP-TB Demonstration Amplifier Circuit Outline





CGHV40200PP-TB Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1	RES,1/8W,1206,1%,100 OHMS	1
R10,R20	RES, 1/16W, 0603, 1%, 10 Ohms	2
C10,C20	CAP, 1.1pF, +/-0.05 pF,0603, ATC600S	2
C11,C21	CAP, 10pF,+/-5%, 0603,ATC600S	2
C12,C22	CAP, 470PF, 5%, 100V,X7R 0603	2
C13,C23,C36,C46	CAP,33000PF, 0805,100V, X7R	4
C37,C47	CAP, 1.0UF, 100V, 10%, X7R, 1210	2
C38,C48	CAP, 33 UF, 20%, G CASE	2
C14,C24	CAP 10UF 16V TANTALUM, 2312	2
C30,C40	CAP, 4.7pF, +/-0.1pF, 250V, 0805,ATC600F	2
C31,C41	CAP, 1.8pF, +/-0.1pF, 250V, 0805,ATC600F	2
C32,C42	CAP, 2.4pF, +/-0.1pF, 250V, 0805,ATC600F	2
C33,C34,C43,C44	CAP, 10 PF +/- 5%,250V, 0805,ATC600F	4
·	PCB, Rogers HTC6035HTC , 0.020 THK, ER 3.6	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST	2
J3,J4	HEADER RT>PLZ .1CEN LK 9POS	2
Q1	CGHV40200PP	1

CGHV40200PP-TB Demonstration Amplifier Circuit

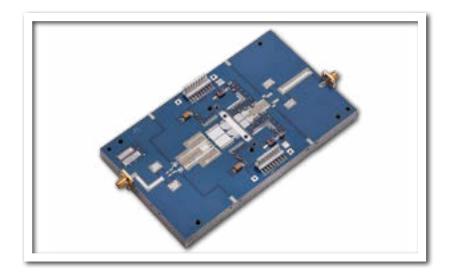






Figure 5. - Small Signal Gain and Return Losses vs Frequency measured in the CGHV40200PP Broadband Amplifier Circuit $V_{DD} = 50 \text{ V}, I_{DO} = 1.2 \text{ A}$

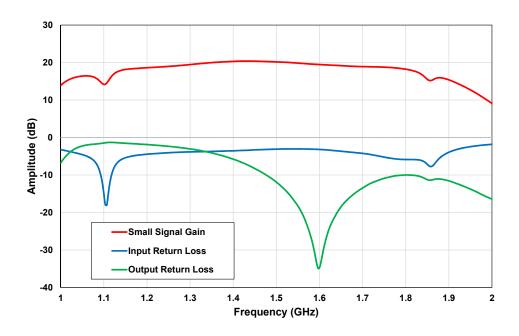
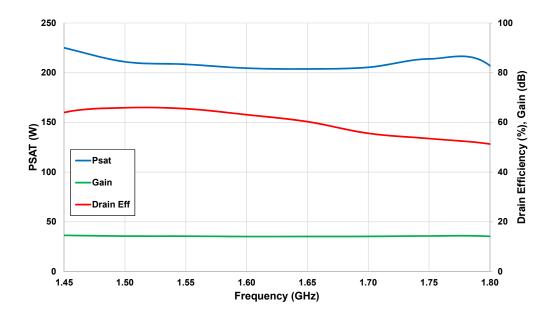
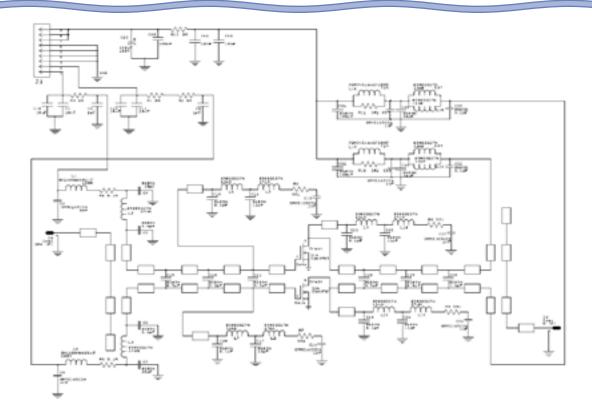


Figure 6. - Saturated Output Power Gain, and Drain Efficiency vs Frequency of the CGHV40200PP measured in the CGHV40200PP Broadband Amplifier Circuit $V_{\text{DD}} = 50V$, $I_{\text{DO}} = 500\text{mA}$

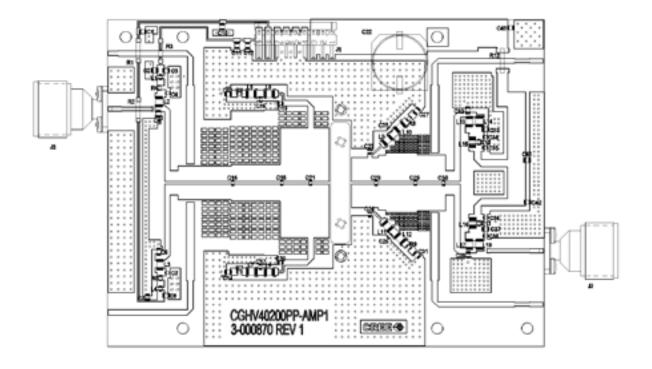




CGHV40200PP-AMP1 Demonstration Amplifier Circuit Schematic

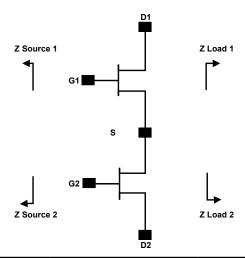


CGHV40200PP-AMP1 Demonstration Amplifier Circuit Outline





Simulated Source and Load Impedances



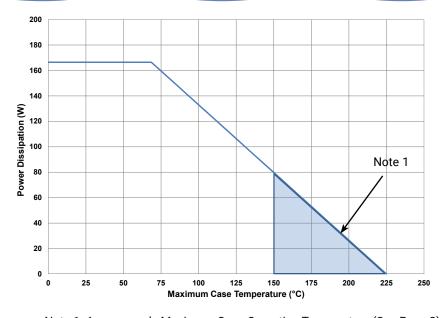
Frequency (MHz)	Z Source (1,2)	Z Load (1,2)
500	2.9 +j4.8	12.8 +j7.3
1000	0.8 +j1.5	9.1 +j5.1
1500	0.9 +-j0.6	5.5 +j3.8
2000	1.1 -j2.2	4.4 +j2.0
2500	1.8 -j4.0	3.8 +j0.5

Note 1. V_{DD} = 50 V, I_{DQ} = 2 x 0.6 A in the 440199 package.

Note 2. Optimized for power gain, P_{SAT} and PAE.

Note 3. When using this device at low frequency, series resistors should be used to maintain amplifier stability.

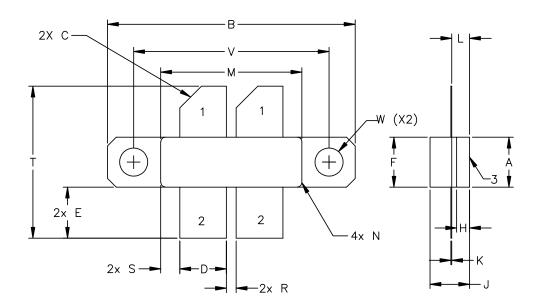
CGHV40200PP Power Dissipation De-rating Curve



Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).



Product Dimensions CGHV40200PP (Package Type 440199)



STYLE 1:

PIN 1. GATE

2. DRAIN

3. SOURCE

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020"
 BEYOND EDGE OF LID.
 LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.225	0.235	5.72	5.97
В	1.135	1.145	28.83	29.00
С	0.10 4	45° REF	2.54	45° REF
D	0.210	0.220	5.33	5.59
Ε	0.230	0.240	5.84	6.00
F	0.225	0.235	5.71	5.97
Н	0.055	0.065	1.40	1.65
J	0.151	0.171	3.84	4.34
К	0.003	0.006	0.08	0.15
L	0.075	0.085	1.91	2.16
М	0.643	0.657	16.30	16.70
N	R.02	0 REF	R0.5	1 REF
R	0.040	0.050	1.00	1.27
S	0.083	0.093	2.10	2.36
Т	0.680	0.720	17.30	18.30
V	0.895	0.905	22.70	22.98
W	ø.130		ø.	3.30

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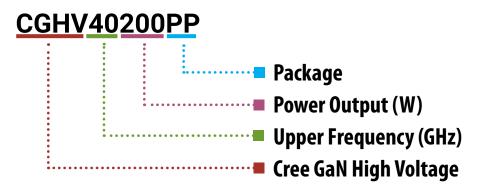


Product Ordering Information

Order Number	Description	Unit of Measure	lmage
CGHV40200PP	GaN HEMT	Each	CARGO
CGHV40200PP-AMP1	Test board with GaN HEMT installed	Each	



Part Number System



Parameter	Value	Units
Upper Frequency ¹	4.0	GHz
Power Output	200	W
Package	Push Pill	-

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
Е	4
F	5
G	6
Н	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.



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